# PROIEK DE

# HIGH SPEED TVS DIODE ARRAY

#### APPLICATIONS

- Ethernet 10/100 Base T 1
- RS-485 /
- ✓ xDSL & ATM
- SCSI & USB /
- Audio/Video I/O Ports

#### IEC COMPATIBILITY (EN61000-4)

- ✓ 64100-4-2 (ESD): Air 15kv, Contact 8kv
- 64100-4-4 (EFT): 40A 5/50ns 1
- ✓ 64100-4-5 (Lightning):

#### **FEATURES**

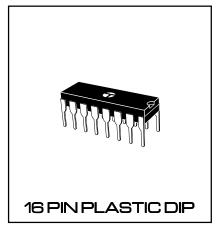
- ✓ Suitable for Low Capacitance High Speed V<sup>2</sup>D Protection
- 500 Watts Peak Pulse Power Dissipation per Line (8/20 μs)
- ✓ Bidirectional Configuration
- ✓ ESD Protection > 40 kilovolts
- ✓ Low Capacitance 15 pF

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- ✓ Available in 5 Voltage Types: 5.0V to 24V
- ✓ Standard Dual-In-Line Package
- ✓ Protects Up to Eight (8) Lines
- ✓ UL 94V-0 Flammability Classification

#### CIRCUIT DIAGRAM & PCB LAYOUT RECOMMENDATION

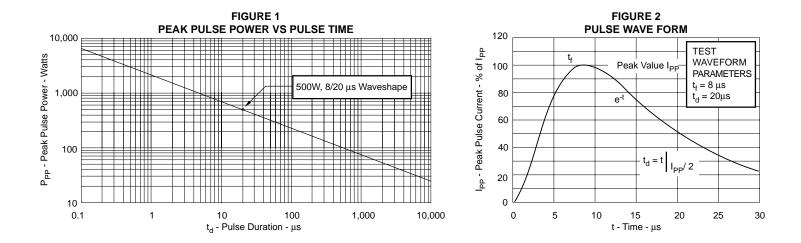
2 2 15 3 3 14 4 4 13 GND VIA 5 12 5 6 6 10 7 8 TO PROTECTED DEVICE



FROM CONNECTOR

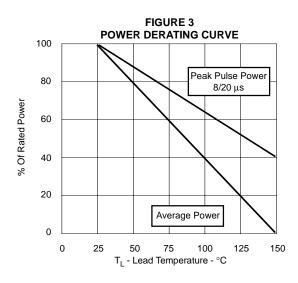
# DEVICE CHARACTERISTICS

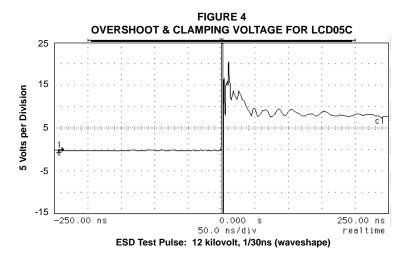
PART STAND-OFF BREAKDOWN CLAMPING CLAMPING L   NUMBER VOLTAGE VOLTAGE VOLTAGE VOLTAGE C   (See Note 1) (See Fig. 2) (See Fig. 2) (See Fig. 2)	E TEMPERATURE Y CYCLE) V <sub>(BR)</sub> MIN.) Ambient Temp MAXIMUM	E -55°C to +150 0.01% Bidirectional:	20 μs Waveshape °C < 1 x 10 <sup>-9</sup> seconds TEMPERATURE
PROTEK RATED MINIMUM MAXIMUM MAXIMUM M   PART STAND-OFF BREAKDOWN CLAMPING CLAMPING L   NUMBER VOLTAGE VOLTAGE VOLTAGE VOLTAGE C   (See Note 1) (See Fig. 2) (See Fig. 2) (See Fig. 2) (See Fig. 2)	MAXIMUM	MAXIMUM	TEMPERATURE
PART STAND-OFF BREAKDOWN CLAMPING CLAMPING L   NUMBER VOLTAGE VOLTAGE VOLTAGE VOLTAGE C   (See Note 1) (See Fig. 2) (See Fig. 2) (See Fig. 2)			TEMPERATURE
@ 1 mA @ l <sub>p</sub> = 1 A V <sub>WM</sub> V <sub>(BR)</sub> V <sub>C</sub> @ 8/20 μs	CURRENT	CAPACITANCE @ 0V, 1 MHz C	OEFFICIENT OF V <sub>(BR)</sub> ⊖V <sub>(BR)</sub>
VOLTS VOLTS V <sub>C</sub> @ I <sub>PP</sub>	μ <b>Ă</b>	pF	mV/°C
LCD05C5.06.09.822V @ 40ALCD08C8.08.512.323.5V @ 22ALCD12C12.013.319.028V @ 25ALCD15C15.016.725.536V @ 20ALCD24C24.026.740.056V @ 12A	100 10 4 4 4	15 15 15 15 15	3 9 16 17 26

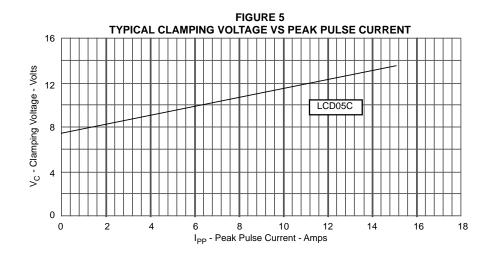


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# DEVICE CHARACTERISTICS







### DEVICE SPECIFIC APPLICATION NOTE

The LCD Series are bidirectional, low capacitance, silicon TVS devices designed to protect multiple data or signal lines. This device provides ESD protection > 40kV and has a 500 Watt peak pulse power dissipation for an 8/20  $\mu$ s pulse per line.

The LCD is ideal for use in protecting multimode transceiver I/O lines and data communications applications such as USB. This low capacitance device allows these types of applications to operate safely without significant signal distortion. When a transient voltage strikes a data line, the device becomes a low impedance path diverting the transient current to ground. TVS devices are capable of clamping both positive and negative transient voltages to a low enough level such that a sensitive IC component will not be damaged.

As shown in Figure 1, a typical RS-485 transceiver application, the LCD protects up to four (4) bidirectional lines where the normal signal voltage is both positive and negative. Each pin pair is symmetrical so that each pair can be connected to both data lines and ground. In order to insure low crosstalk and isolation, each line/ground pin pair is electrically independent of each other. Pins 1, 2, 3, 4, 9, 10, 11 and 12 are connected to ground. Pins 5, 6, 7, 8,13, 14,15 and 16 are connected to the data lines.

In addition, the LCD can protect up to four USB ports. As shown in Figure 2, in order to provide common-mode protection, pins 16 through 10 can be connected to the data lines and pins 1 through 7 can be connected to ground.

#### **Circuit Board Layout Recommendations**

Circuit board layout is critical for Electromagnetic Compatibility (EMC) protection. The following guidelines are recommended:

✓ The LCD should be placed near the input terminals or connectors. By placing the TVS close to the connectors, the device will divert the transient current immediately before it can be coupled into the nearby traces.

✓ The path length between the TVS device and the protected line should be minimized.

✓ All conductive loops including power and ground loops should be minimized.

✓ The transient current return path to ground should be kept as short as possible to reduce parasitic inductance.

✓ Ground planes should be used whenever possible. For Multilayer PCBs, use ground vias.

Figure 1. Typical RS-485 Transceiver Protection Circuit (Differential & Common-Mode)

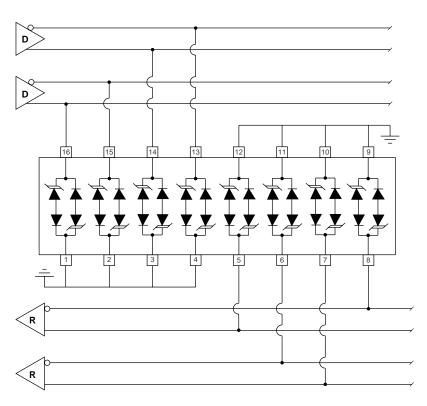
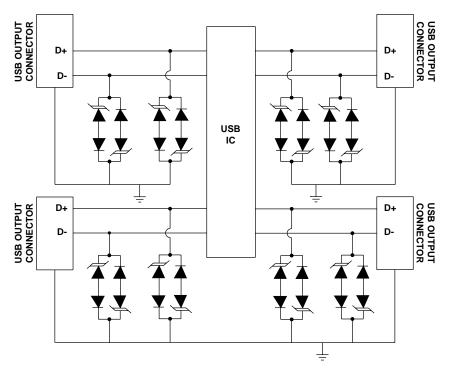


Figure 2. Typical Common-Mode USB Protection Circuit





#### SPICE MODEL & PARAMETERS

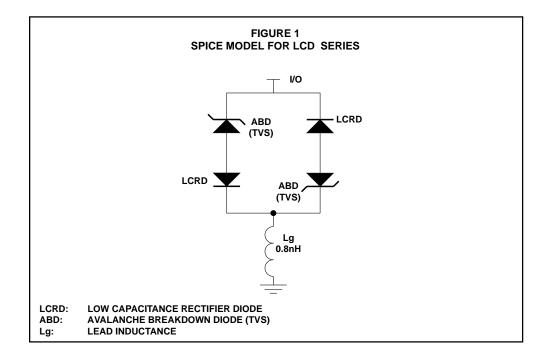
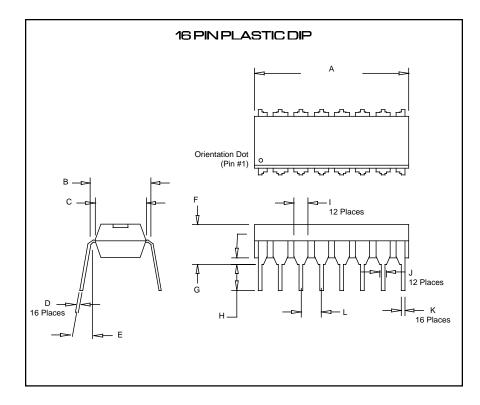


TABLE 1 - SPICE PARAMETERS					
PARAMETER	UNIT	(ABD) TVS	LCRD		
BV IBV Cjo Is Vj M N Rs	V μA PF Α V - Ohms	See Table 2 1 See Table 2 See Table 2 0.6 0.33 1 See Table 2	200 0.01 5 10E-14 0.6 0.33 1 0.31		
TT EG	μs eV	0.1 1.11	0.31 1 1.11		

TABLE 2 - ABD SPECIFIC SPICE PARAMETERS					
PART NO.	BV (Volts)	Cjo (pF)	ls (Amps)	Rs (Ohms)	
LCD05C LCD08C LCD12C LCD15C LCD24C	6.0 8.5 13.3 16.7 26.7	880 481 319 238 210	10E-12 10E-14 10E-14 10E-14 10E-14 10E-14	0.09 0.18 0.22 0.31 0.93	

# PACKAGE OUTLINES & DIMENSIONS



16 PIN DIP DIMENSIONS					
	MILLIM	IETERS	INCHES		
DIM	MIN	МАХ	MIN	МАХ	
А	-	19.8	-	0.780	
В	6.10	6.60	0.240	0.260	
С	7.37	7.87	0.290	0.310	
D	0.25	0.36	0.010	0.014	
E	0°	10°	0°	10°	
F	0.51	-	0.020	-	
G	-	5.08	-	0.200	
н	3.17	-	0.125	-	
I.	-	1.78	-	0.070	
J	0.84 TYP	0.84 TYP	0.033 TYP	0.033 TYP	
к	0.381	0.533	0.021	0.051	
L	2.54 TYP	2.54 TYP	0.100 TYP	0.100 TYP	

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